



**QUALCOMM Incorporated**

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22 June 2009

Mr. Joern Krause and Ms. Susanna Kooistra  
3GPP MCC  
ETSI  
650, route des Lucioles  
06921 Sophia-Antipolis Cedex  
France

Subject: Nomination of candidate for the 3GPP TSG RAN WG2 Vice-Chairman

Dear Mr. Krause and Ms. Kooistra:

QUALCOMM is pleased to nominate Mr. Etienne Chaponniere for the position of vice-chair of 3GPP TSG-RAN WG2. Etienne Chaponniere works for QUALCOMM Europe, Inc. and represents QUALCOMM Europe S.A.R.L., an ETSI member, in 3GPP.

A brief curriculum vitae of Etienne Chaponniere is attached.

Best Regards,

A handwritten signature in black ink, appearing to read "Edward G. Tiedemann, Jr." with a stylized flourish at the end.

Edward G. Tiedemann, Jr.  
Senior Vice-President, Engineering  
QUALCOMM Incorporated

## **Etienne Chaponniere**

Etienne Chaponniere graduated in 1999 with a Master's degree in Telecommunications from the Ecole Polytechnique Federale de Lausanne, Switzerland.

Since joining Qualcomm in 1999, he has worked as a systems engineer focusing on layer 2 and layer 3 of various wireless technologies. In January 2005, he started attending TSG-RAN WG2, contributing to HSUPA and major release 7 and release 8 features. Etienne was elected in the position of vice-chair of TSG-RAN WG2 in June 2008 and has been chairing the UTRA sessions since then.